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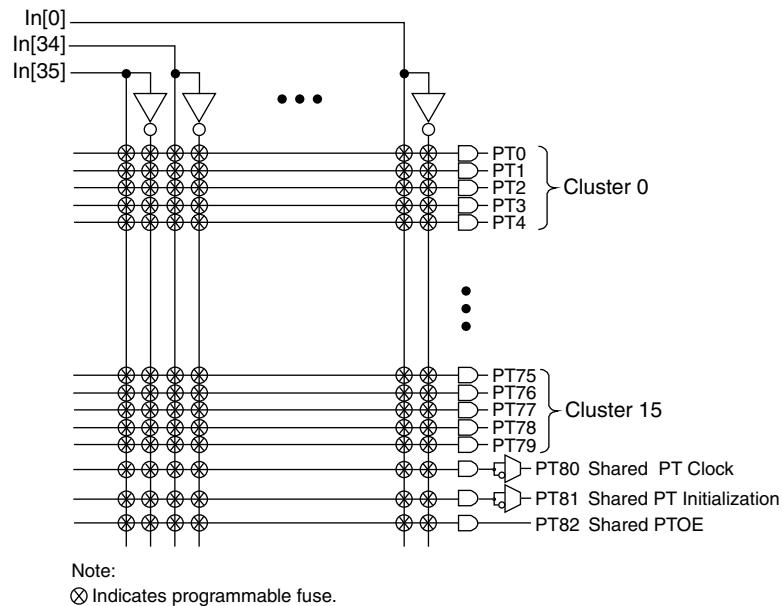
[Understanding Embedded - CPLDs \(Complex Programmable Logic Devices\)](#)

Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixed-function ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

Applications of Embedded - CPLDs

Details

Product Status	Obsolete
Programmable Type	In System Programmable
Delay Time tpd(1) Max	10 ns
Voltage Supply - Internal	2.3V ~ 2.7V
Number of Logic Elements/Blocks	16
Number of Macrocells	256
Number of Gates	-
Number of I/O	160
Operating Temperature	-40°C ~ 105°C (TJ)
Mounting Type	Surface Mount
Package / Case	256-BGA
Supplier Device Package	256-FPBGA (17x17)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lc4256b-10fn256bi

Figure 3. AND Array

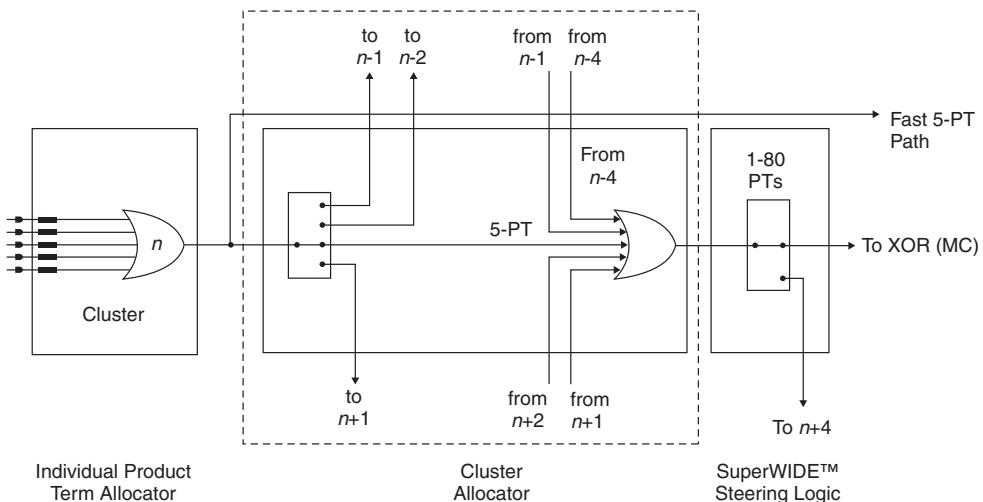
Enhanced Logic Allocator

Within the logic allocator, product terms are allocated to macrocells in product term clusters. Each product term cluster is associated with a macrocell. The cluster size for the ispMACH 4000 family is 4+1 (total 5) product terms. The software automatically considers the availability and distribution of product term clusters as it fits the functions within a GLB. The logic allocator is designed to provide three speed paths: 5-PT fast bypass path, 20-PT Speed Locking path and an up to 80-PT path. The availability of these three paths lets designers trade timing variability for increased performance.

The enhanced Logic Allocator of the ispMACH 4000 family consists of the following blocks:

- Product Term Allocator
- Cluster Allocator
- Wide Steering Logic

Figure 4 shows a macrocell slice of the Logic Allocator. There are 16 such slices in the GLB.

Figure 4. Macrocell Slice

IEEE 1532-Compliant In-System Programming

Programming devices in-system provides a number of significant benefits including: rapid prototyping, lower inventory levels, higher quality and the ability to make in-field modifications. All ispMACH 4000 devices provide In-System Programming (ISP™) capability through the Boundary Scan Test Access Port. This capability has been implemented in a manner that ensures that the port remains complaint to the IEEE 1149.1 standard. By using IEEE 1149.1 as the communication interface through which ISP is achieved, users get the benefit of a standard, well-defined interface. All ispMACH 4000 devices are also compliant with the IEEE 1532 standard.

The ispMACH 4000 devices can be programmed across the commercial temperature and voltage range. The PC-based Lattice software facilitates in-system programming of ispMACH 4000 devices. The software takes the JEDEC file output produced by the design implementation software, along with information about the scan chain, and creates a set of vectors used to drive the scan chain. The software can use these vectors to drive a scan chain via the parallel port of a PC. Alternatively, the software can output files in formats understood by common automated test equipment. This equipment can then be used to program ispMACH 4000 devices during the testing of a circuit board.

User Electronic Signature

The User Electronic Signature (UES) allows the designer to include identification bits or serial numbers inside the device, stored in E²CMOS memory. The ispMACH 4000 device contains 32 UES bits that can be configured by the user to store unique data such as ID codes, revision numbers or inventory control codes.

Security Bit

A programmable security bit is provided on the ispMACH 4000 devices as a deterrent to unauthorized copying of the array configuration patterns. Once programmed, this bit defeats readback of the programmed pattern by a device programmer, securing proprietary designs from competitors. Programming and verification are also defeated by the security bit. The bit can only be reset by erasing the entire device.

Hot Socketing

The ispMACH 4000 devices are well-suited for applications that require hot socketing capability. Hot socketing a device requires that the device, during power-up and down, can tolerate active signals on the I/Os and inputs without being damaged. Additionally, it requires that the effects of I/O pin loading be minimal on active signals. The ispMACH 4000 devices provide this capability for input voltages in the range 0V to 3.0V.

Density Migration

The ispMACH 4000 family has been designed to ensure that different density devices in the same package have the same pin-out. Furthermore, the architecture ensures a high success rate when performing design migration from lower density parts to higher density parts. In many cases, it is possible to shift a lower utilization design targeted for a high density device to a lower density device. However, the exact details of the final resource utilization will impact the likely success in each case.

Supply Current, ispMACH 4000Z (Cont.)

Over Recommended Operating Conditions

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
ispMACH 4256ZC						
ICC ^{1, 2, 3, 5}	Operating Power Supply Current	Vcc = 1.8V, TA = 25°C	—	341	—	µA
		Vcc = 1.9V, TA = 70°C	—	361	—	µA
		Vcc = 1.9V, TA = 85°C	—	372	—	µA
		Vcc = 1.9V, TA = 125°C	—	468	—	µA
ICC ^{4, 5}	Standby Power Supply Current	Vcc = 1.8V, TA = 25°C	—	13	—	µA
		Vcc = 1.9V, TA = 70°C	—	32	55	µA
		Vcc = 1.9V, TA = 85°C	—	43	90	µA
		Vcc = 1.9V, TA = 125°C	—	135	—	µA

1. TA = 25°C, frequency = 1.0 MHz.

2. Device configured with 16-bit counters.

3. ICC varies with specific device configuration and operating frequency.

4. VCCO = 3.6V, VIN = 0V or VCCO, bus maintenance turned off. VIN above VCCO will add transient current above the specified standby ICC.

5. Includes VCCO current without output loading.

ispMACH 4000Z Internal Timing Parameters (Cont.)**Over Recommended Operating Conditions**

Parameter	Description	-35		-37		-42		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
t_{GPTOE}	Global PT OE Delay	—	1.9	—	2.35	—	2.60	ns
t_{PTOE}	Macrocell PT OE Delay	—	2.4	—	3.35	—	2.60	ns

Note: Internal Timing Parameters are not tested and are for reference only. Refer to the timing model in this data sheet for further details.

Timing v.2.2

Signal Descriptions

Signal Names		Description
TMS		Input – This pin is the IEEE 1149.1 Test Mode Select input, which is used to control the state machine.
TCK		Input – This pin is the IEEE 1149.1 Test Clock input pin, used to clock through the state machine.
TDI		Input – This pin is the IEEE 1149.1 Test Data In pin, used to load data.
TDO		Output – This pin is the IEEE 1149.1 Test Data Out pin used to shift data out.
GOE0/IO, GOE1/IO		These pins are configured to be either Global Output Enable Input or as general I/O pins.
GND		Ground
NC		Not Connected
V _{CC}		The power supply pins for logic core and JTAG port.
CLK0/I, CLK1/I, CLK2/I, CLK3/I		These pins are configured to be either CLK input or as an input.
V _{CC00} , V _{CC01}		The power supply pins for each I/O bank.
yzz		Input/Output ¹ – These are the general purpose I/O used by the logic array. y is GLB reference (alpha) and z is macrocell reference (numeric). z: 0-15.
		ispMACH 4032
		ispMACH 4064
		ispMACH 4128
		ispMACH 4256
		ispMACH 4384
		ispMACH 4512
		y: A-B
		y: A-D
		y: A-H
		y: A-P
		y: A-P, AX-HX
		y: A-P, AX-PX

1. In some packages, certain I/Os are only available for use as inputs. See the signal connections table for details.

ispMACH 4000V/B/C ORP Reference Table

	4032V/B/C		4064V/B/C			4128V/B/C			4256V/B/C				4384V/B/C		4512V/B/C	
Number of I/Os	30 ¹	32	30 ²	32	64	64	92 ³	96	64	96 ⁴	128	160	128	192	128	208
Number of GLBs	2	2	4	4	4	8	8	8	16	16	16	16	16	16	16	16
Number of I/Os / GLB	16	16	8	8	16	8	12	12	4	8	8	10	8	8	8	Mixture of 8 & 4 ⁵
Reference ORP Table	16 I/Os / GLB		8 I/Os / GLB		16 I/Os / GLB		8 I/Os / GLB		12 I/Os / GLB		4 I/Os / GLB		8 I/Os / GLB		10 I/Os / GLB	
															8 I/Os / GLB	
															4 I/Os / GLB	

1. 32-macrocell device, 44 TQFP: 2 GLBs have 15 out of 16 I/Os bonded out.

2. 64-macrocells device, 44 TQFP: 2 GLBs have 7 out of 8 I/Os bonded out.

3. 128-macrocell device, 128 TQFP: 4 GLBs have 11 out of 12 I/Os

4. 256-macrocell device, 144 TQFP: 16 GLBs have 6 I/Os per

5. 512-macrocell device: 20 GLBs have 8 I/Os per, 12 GLBs have 4 I/Os per

ispMACH 4000Z ORP Reference Table

	4032Z		4064Z			4128Z			4256Z			
Number of I/Os	32	32	64			64	96	64	96 ¹	128		
Number of GLBs	2	4	4			8	8	16	16	16		
Number of I/Os / GLB	16	8	16			8	12	4	8	8		
Reference ORP Table	16 I/Os / GLB		8 I/Os / GLB		16 I/Os / GLB		8 I/Os / GLB		12 I/Os / GLB		4 I/Os / GLB	

1. 256-macrocell device, 132 csBGA: 16 GLBs have 6 I/Os per

**ispMACH 4032V/B/C and 4064V/B/C Logic Signal Connections:
44-Pin TQFP**

Pin Number	Bank Number	ispMACH 4032V/B/C		ispMACH 4064V/B/C	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
1	-	TDI	-	TDI	-
2	0	A5	A^5	A10	A^5
3	0	A6	A^6	A12	A^6
4	0	A7	A^7	A14	A^7
5	0	GND (Bank 0)	-	GND (Bank 0)	-
6	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-
7	0	A8	A^8	B0	B^0
8	0	A9	A^9	B2	B^1
9	0	A10	A^10	B4	B^2
10	-	TCK	-	TCK	-
11	-	VCC	-	VCC	-
12	-	GND	-	GND	-
13	0	A12	A^12	B8	B^4
14	0	A13	A^13	B10	B^5
15	0	A14	A^14	B12	B^6
16	0	A15	A^15	B14	B^7
17	1	CLK2/I	-	CLK2/I	-
18	1	B0	B^0	C0	C^0
19	1	B1	B^1	C2	C^1
20	1	B2	B^2	C4	C^2
21	1	B3	B^3	C6	C^3
22	1	B4	B^4	C8	C^4
23	-	TMS	-	TMS	-
24	1	B5	B^5	C10	C^5
25	1	B6	B^6	C12	C^6
26	1	B7	B^7	C14	C^7
27	1	GND (Bank 1)	-	GND (Bank 1)	-
28	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-
29	1	B8	B^8	D0	D^0
30	1	B9	B^9	D2	D^1
31	1	B10	B^10	D4	D^2
32	-	TDO	-	TDO	-
33	-	VCC	-	VCC	-
34	-	GND	-	GND	-
35	1	B12	B^12	D8	D^4
36	1	B13	B^13	D10	D^5
37	1	B14	B^14	D12	D^6
38	1	B15/GOE1	B^15	D14/GOE1	D^7
39	0	CLK0/I	-	CLK0/I	-
40	0	A0/GOE0	A^0	A0/GOE0	A^0
41	0	A1	A^1	A2	A^1

**ispMACH 4032V/B/C and 4064V/B/C Logic Signal Connections:
44-Pin TQFP (Cont.)**

Pin Number	Bank Number	ispMACH 4032V/B/C		ispMACH 4064V/B/C	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
42	0	A2	A^2	A4	A^2
43	0	A3	A^3	A6	A^3
44	0	A4	A^4	A8	A^4

**ispMACH 4032V/B/C/Z and 4064V/B/C/Z Logic Signal Connections:
48-Pin TQFP**

Pin Number	Bank Number	ispMACH 4032V/B/C/Z		ispMACH 4064V/B/C		ispMACH 4064Z	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
1	-	TDI	-	TDI	-	TDI	-
2	0	A5	A^5	A10	A^5	A8	A^5
3	0	A6	A^6	A12	A^6	A10	A^6
4	0	A7	A^7	A14	A^7	A11	A^7
5	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
6	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
7	0	A8	A^8	B0	B^0	B15	B^7
8	0	A9	A^9	B2	B^1	B12	B^6
9	0	A10	A^10	B4	B^2	B10	B^5
10	0	A11	A^11	B6	B^3	B8	B^4
11	-	TCK	-	TCK	-	TCK	-
12	-	VCC	-	VCC	-	VCC	-
13	-	GND	-	GND	-	GND	-
14	0	A12	A^12	B8	B^4	B6	B^3
15	0	A13	A^13	B10	B^5	B4	B^2
16	0	A14	A^14	B12	B^6	B2	B^1
17	0	A15	A^15	B14	B^7	B0	B^0
18	0	CLK1/I	-	CLK1/I	-	CLK1/I	-
19	1	CLK2/I	-	CLK2/I	-	CLK2/I	-
20	1	B0	B^0	C0	C^0	C0	C^0
21	1	B1	B^1	C2	C^1	C1	C^1
22	1	B2	B^2	C4	C^2	C2	C^2
23	1	B3	B^3	C6	C^3	C4	C^3
24	1	B4	B^4	C8	C^4	C6	C^4
25	-	TMS	-	TMS	-	TMS	-
26	1	B5	B^5	C10	C^5	C8	C^5
27	1	B6	B^6	C12	C^6	C10	C^6
28	1	B7	B^7	C14	C^7	C11	C^7
29	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
30	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
31	1	B8	B^8	D0	D^0	D15	D^7
32	1	B9	B^9	D2	D^1	D12	D^6

ispMACH 4032Z and 4064Z Logic Signal Connections: 56-Ball csBGA (Cont.)

Ball Number	Bank Number	ispMACH 4032Z		ispMACH 4064Z	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
K5	0	A15	A^15	B0	B^0
H6	0	CLK1/I	-	CLK1/I	-
K6	1	CLK2/I	-	CLK2/I	-
H7	1	B0	B^0	C0	C^0
K7	1	B1	B^1	C1	C^1
K8	1	B2	B^2	C2	C^2
K9	1	B3	B^3	C4	C^3
K10	1	B4	B^4	C6	C^4
J10	-	TMS	-	TMS	-
H8	1	B5	B^5	C8	C^5
H10	1	B6	B^6	C10	C^6
G10	1	B7	B^7	C11	C^7
G8	1	GND (Bank 1)	-	GND (Bank 1)	-
F8	1	NC ¹	-	I ¹	-
F10	1	NC ¹	-	I ¹	-
E8	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-
E10	1	B8	B^8	D15	D^7
D8	1	B9	B^9	D12	D^6
D10	1	B10	B^10	D10	D^5
C10	1	B11	B^11	D8	D^4
B10	1	NC ¹	-	I ¹	-
A10	-	TDO	-	TDO	-
A9	-	VCC	-	VCC	-
C8	-	GND	-	GND	-
A8	1	NC ¹	-	I ¹	-
A7	1	B12	B^12	D6	D^3
C7	1	B13	B^13	D4	D^2
C6	1	B14	B^14	D2	D^1
A6	1	B15/GOE1	B^15	D0/GOE1	D^0
C5	1	CLK3/I	-	CLK3/I	-
A5	0	CLK0/I	-	CLK0/I	-
C4	0	A0/GOE0	A^0	A0/GOE0	A^0
A4	0	A1	A^1	A1	A^1
A3	0	A2	A^2	A2	A^2
A2	0	A3	A^3	A4	A^3
A1	0	A4	A^4	A6	A^4

1. For device migration considerations, these NC pins are input signal pins in ispMACH 4064Z devices.

**ispMACH 4064V/B/C/Z, 4128V/B/C/Z, 4256V/B/C/Z Logic Signal Connections:
100-Pin TQFP**

Pin Number	Bank Number	ispMACH 4064V/B/C/Z		ispMACH 4128V/B/C/Z		ispMACH 4256V/B/C/Z	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
1	-	GND	-	GND	-	GND	-
2	-	TDI	-	TDI	-	TDI	-
3	0	A8	A^8	B0	B^0	C12	C^3
4	0	A9	A^9	B2	B^1	C10	C^2
5	0	A10	A^10	B4	B^2	C6	C^1
6	0	A11	A^11	B6	B^3	C2	C^0
7	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
8	0	A12	A^12	B8	B^4	D12	D^3
9	0	A13	A^13	B10	B^5	D10	D^2
10	0	A14	A^14	B12	B^6	D6	D^1
11	0	A15	A^15	B13	B^7	D4	D^0
12*	0	I	-	I	-	I	-
13	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
14	0	B15	B^15	C14	C^7	E4	E^0
15	0	B14	B^14	C12	C^6	E6	E^1
16	0	B13	B^13	C10	C^5	E10	E^2
17	0	B12	B^12	C8	C^4	E12	E^3
18	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
19	0	B11	B^11	C6	C^3	F2	F^0
20	0	B10	B^10	C5	C^2	F6	F^1
21	0	B9	B^9	C4	C^1	F10	F^2
22	0	B8	B^8	C2	C^0	F12	F^3
23*	0	I	-	I	-	I	-
24	-	TCK	-	TCK	-	TCK	-
25	-	VCC	-	VCC	-	VCC	-
26	-	GND	-	GND	-	GND	-
27*	0	I	-	I	-	I	-
28	0	B7	B^7	D13	D^7	G12	G^3
29	0	B6	B^6	D12	D^6	G10	G^2
30	0	B5	B^5	D10	D^5	G6	G^1
31	0	B4	B^4	D8	D^4	G2	G^0
32	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
33	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
34	0	B3	B^3	D6	D^3	H12	H^3
35	0	B2	B^2	D4	D^2	H10	H^2
36	0	B1	B^1	D2	D^1	H6	H^1
37	0	B0	B^0	D0	D^0	H2	H^0
38	0	CLK1/I	-	CLK1/I	-	CLK1/I	-
39	1	CLK2/I	-	CLK2/I	-	CLK2/I	-
40	-	VCC	-	VCC	-	VCC	-
41	1	C0	C^0	E0	E^0	I2	I^0

ispMACH 4128V/B/C Logic Signal Connections: 128-Pin TQFP (Cont.)

Pin Number	Bank Number	ispMACH 4128V/B/C	
		GLB/MC/Pad	ORP
62	1	E10	E^8
63	1	E12	E^9
64	1	E14	E^11
65	1	GND	-
66	1	TMS	-
67	1	VCCO (Bank 1)	-
68	1	F0	F^0
69	1	F1	F^1
70	1	F2	F^2
71	1	F4	F^3
72	1	F5	F^4
73	1	F6	F^5
74	1	GND (Bank 1)	-
75	1	F8	F^6
76	1	F9	F^7
77	1	F10	F^8
78	1	F12	F^9
79	1	F13	F^10
80	1	F14	F^11
81	1	VCCO (Bank 1)	-
82	1	G14	G^11
83	1	G13	G^10
84	1	G12	G^9
85	1	G10	G^8
86	1	G9	G^7
87	1	G8	G^6
88	1	GND (Bank 1)	-
89	1	G6	G^5
90	1	G5	G^4
91	1	G4	G^3
92	1	G2	G^2
93	1	G0	G^0
94	1	VCCO (Bank 1)	-
95	1	TDO	-
96	1	VCC	-
97	1	GND	-
98	1	H14	H^11
99	1	H13	H^10
100	1	H12	H^9
101	1	H10	H^8
102	1	H9	H^7
103	1	H8	H^6
104	1	GND (Bank 1)	-

**ispMACH 4256V/B/C/Z, 4384V/B/C, 4512V/B/C, Logic Signal Connections:
176-Pin TQFP (Cont.)**

Pin Number	Bank Number	ispMACH 4256V/B/C/Z		ispMACH 4384V/B/C		ispMACH 4512V/B/C	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
142	1	O0	O^0	GX0	GX^0	OX0	OX^0
143	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
144	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
145	1	P14	P^7	HX14	HX^7	PX14	PX^7
146	1	P12	P^6	HX12	HX^6	PX12	PX^6
147	1	P10	P^5	HX10	HX^5	PX10	PX^5
148	1	P8	P^4	HX8	HX^4	PX8	PX^4
149	1	P6	P^3	HX6	HX^3	PX6	PX^3
150	1	P4	P^2	HX4	HX^2	PX4	PX^2
151	1	P2/GOE1	P^1	HX2/GOE1	HX^1	PX2/GOE1	PX^1
152	1	P0	P^0	HX0	HX^0	PX0	PX^0
153	-	GND	-	GND	-	GND	-
154	1	CLK3/I	-	CLK3/I	-	CLK3/I	-
155	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
156	0	CLK0/I	-	CLK0/I	-	CLK0/I	-
157	-	VCC	-	VCC	-	VCC	-
158	0	A0	A^0	A0	A^0	A0	A^0
159	0	A2/GOE0	A^1	A2/GOE0	A^1	A2//GOE0	A^1
160	0	A4	A^2	A4	A^2	A4	A^2
161	0	A6	A^3	A6	A^3	A6	A^3
162	0	A8	A^4	A8	A^4	A8	A^4
163	0	A10	A^5	A10	A^5	A10	A^5
164	0	A12	A^6	A12	A^6	A12	A^6
165	0	A14	A^7	A14	A^7	A14	A^7
166	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
167	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
168	0	B0	B^0	B0	B^0	B0	B^0
169	0	B2	B^1	B2	B^1	B2	B^1
170	0	B4	B^2	B4	B^2	B4	B^2
171	0	B6	B^3	B6	B^3	B6	B^3
172	0	B8	B^4	B8	B^4	B8	B^4
173	0	B10	B^5	B10	B^5	B10	B^5
174	0	B12	B^6	B12	B^6	B12	B^6
175	0	B14	B^7	B14	B^7	B14	B^7
176	-	VCC	-	VCC	-	VCC	-

**ispMACH 4256V/B/C, 4384V/B/C, 4512V/B/C Logic Signal Connections:
256-Ball ftBGA/fpBGA**

Ball Number	I/O Bank	ispMACH 4256V/B/C 128-I/O		ispMACH 4256V/B/C 160-I/O		ispMACH 4384V/B/C		ispMACH 4512V/B/C	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
-	-	-	-	-	-	VCC	-	VCC	-
-	-	GND	-	GND	-	GND	-	GND	-
C3	-	TDI	-	TDI	-	TDI	-	TDI	-
-	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
B1	0	C14	C^7	C14	C^9	C14	C^7	C14	C^7
F5	0	C12	C^6	C12	C^8	C12	C^6	C12	C^6
D3	0	C10	C^5	C10	C^7	C10	C^5	C10	C^5
C1	0	C8	C^4	C9	C^6	C8	C^4	C8	C^4
C2	0	C6	C^3	C8	C^5	C6	C^3	C6	C^3
E3	0	C4	C^2	C6	C^4	C4	C^2	C4	C^2
D2	0	C2	C^1	C4	C^3	C2	C^1	C2	C^1
F6	0	C0	C^0	C2	C^2	C0	C^0	C0	C^0
D1	0	NC	-	C1	C^1	F6	F^3	H0	H^0
E2	0	NC	-	C0	C^0	F4	F^2	H4	H^1
E4	0	NC	-	NC	-	D6	D^3	F4	F^2
G5	0	NC	-	NC	-	D4	D^2	F6	F^3
E1	0	NC	-	NC	-	NC	-	F8	F^4
-	0	-	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
-	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
F2	0	NC	-	NC	-	NC	-	F10	F^5
F1	0	NC	-	NC	-	D2	D^1	F12	F^6
G1	0	NC	-	NC	-	D0	D^0	F14	F^7
G6	0	NC	-	D14	D^9	F2	F^1	H8	H^2
G4	0	NC	-	D12	D^8	F0	F^0	H12	H^3
H6	0	D14	D^7	D10	D^7	E14	E^7	G14	G^7
G3	0	D12	D^6	D9	D^6	E12	E^6	G12	G^6
H5	0	D10	D^5	D8	D^5	E10	E^5	G10	G^5
G2	0	D8	D^4	D6	D^4	E8	E^4	G8	G^4
H1	0	D6	D^3	D4	D^3	E6	E^3	G6	G^3
H2	0	D4	D^2	D2	D^2	E4	E^2	G4	G^2
H3	0	D2	D^1	D1	D^1	E2	E^1	G2	G^1
H4	0	D0	D^0	D0	D^0	E0	E^0	G0	G^0
-	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
-	0	-	-	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
J4	0	E0	E^0	E0	E^0	H0	H^0	J0	J^0
J3	0	E2	E^1	E1	E^1	H2	H^1	J2	J^1
J2	0	E4	E^2	E2	E^2	H4	H^2	J4	J^2
J1	0	E6	E^3	E4	E^3	H6	H^3	J6	J^3
K1	0	E8	E^4	E6	E^4	H8	H^4	J8	J^4
J5	0	E10	E^5	E8	E^5	H10	H^5	J10	J^5
K2	0	E12	E^6	E9	E^6	H12	H^6	J12	J^6

**ispMACH 4256V/B/C, 4384V/B/C, 4512V/B/C Logic Signal Connections:
256-Ball ftBGA/fpBGA (Cont.)**

Ball Number	I/O Bank	ispMACH 4256V/B/C 128-I/O		ispMACH 4256V/B/C 160-I/O		ispMACH 4384V/B/C		ispMACH 4512V/B/C	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
R5	0	NC	-	NC	-	NC	-	L4	L^1
T5	0	NC	-	NC	-	I2	I^1	L8	L^2
R6	0	NC	-	NC	-	I0	I^0	L12	L^3
T6	0	NC	-	H14	H^9	G12	G^6	M8	M^2
N7	0	NC	-	H12	H^8	G14	G^7	M12	M^3
P7	0	H14	H^7	H10	H^7	L14	L^7	P14	P^7
R7	0	H12	H^6	H9	H^6	L12	L^6	P12	P^6
L8	0	H10	H^5	H8	H^5	L10	L^5	P10	P^5
T7	0	H8	H^4	H6	H^4	L8	L^4	P8	P^4
M8	0	H6	H^3	H4	H^3	L6	L^3	P6	P^3
N8	0	H4	H^2	H2	H^2	L4	L^2	P4	P^2
R8	0	H2	H^1	H1	H^1	L2	L^1	P2	P^1
P8	0	H0	H^0	H0	H^0	L0	L^0	P0	P^0
-	-	GND	-	GND	-	GND	-	GND	-
T8	0	CLK1/I	-	CLK1/I	-	CLK1/I	-	CLK1/I	-
-	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
N9	1	CLK2/I	-	CLK2/I	-	CLK2/I	-	CLK2/I	-
-	-	VCC	-	VCC	-	VCC	-	VCC	-
P9	1	I0	I^0	I0	I^0	M0	M^0	AX0	AX^0
R9	1	I2	I^1	I1	I^1	M2	M^1	AX2	AX^1
T9	1	I4	I^2	I2	I^2	M4	M^2	AX4	AX^2
T10	1	I6	I^3	I4	I^3	M6	M^3	AX6	AX^3
R10	1	I8	I^4	I6	I^4	M8	M^4	AX8	AX^4
M9	1	I10	I^5	I8	I^5	M10	M^5	AX10	AX^5
P10	1	I12	I^6	I9	I^6	M12	M^6	AX12	AX^6
L9	1	I14	I^7	I10	I^7	M14	M^7	AX14	AX^7
N10	1	NC	-	I12	I^8	BX14	BX^7	DX0	DX^0
T11	1	NC	-	I14	I^9	BX12	BX^6	DX4	DX^1
R11	1	NC	-	NC	-	P0	P^0	EX0	EX^0
T12	1	NC	-	NC	-	P2	P^1	EX4	EX^1
N12	1	NC	-	NC	-	NC	-	EX8	EX^2
-	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
-	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
R12	1	NC	-	NC	-	NC	-	EX12	EX^3
T13	1	NC	-	J0	J^0	BX10	BX^5	DX8	DX^2
P12	1	NC	-	J1	J^1	BX8	BX^4	DX12	DX^3
M10	1	J0	J^0	J2	J^2	N0	N^0	BX0	BX^0
R13	1	J2	J^1	J4	J^3	N2	N^1	BX2	BX^1
L10	1	J4	J^2	J6	J^4	N4	N^2	BX4	BX^2
T14	1	J6	J^3	J8	J^5	N6	N^3	BX6	BX^3
M11	1	J8	J^4	J9	J^6	N8	N^4	BX8	BX^4

Ordering Information

Note: ispMACH 4000 devices are all dual marked except the slowest commercial speed grade ispMACH 4000Z devices. For example, the commercial speed grade LC4128C-5T100C is also marked with the industrial grade -75I. The commercial grade is always one speed grade faster than the associated dual mark industrial grade. The slowest commercial speed grade ispMACH 4000Z devices are marked as commercial grade only.

Conventional Packaging

ispMACH 4000ZC (Zero Power, 1.8V) Commercial Devices

Device	Part Number	Macrocells	Voltage	t _{PD}	Package	Pin/Ball Count	I/O	Grade
LC4032ZC	LC4032ZC-35M56C	32	1.8	3.5	csBGA	56	32	C
	LC4032ZC-5M56C	32	1.8	5	csBGA	56	32	C
	LC4032ZC-75M56C	32	1.8	7.5	csBGA	56	32	C
	LC4032ZC-35T48C	32	1.8	3.5	TQFP	48	32	C
	LC4032ZC-5T48C	32	1.8	5	TQFP	48	32	C
	LC4032ZC-75T48C	32	1.8	7.5	TQFP	48	32	C
LC4064ZC	LC4064ZC-37M132C	64	1.8	3.7	csBGA	132	64	C
	LC4064ZC-5M132C	64	1.8	5	csBGA	132	64	C
	LC4064ZC-75M132C	64	1.8	7.5	csBGA	132	64	C
	LC4064ZC-37T100C	64	1.8	3.7	TQFP	100	64	C
	LC4064ZC-5T100C	64	1.8	5	TQFP	100	64	C
	LC4064ZC-75T100C	64	1.8	7.5	TQFP	100	64	C
	LC4064ZC-37M56C	64	1.8	3.7	csBGA	56	32	C
	LC4064ZC-5M56C	64	1.8	5	csBGA	56	32	C
	LC4064ZC-75M56C	64	1.8	7.5	csBGA	56	32	C
	LC4064ZC-37T48C	64	1.8	3.7	TQFP	48	32	C
	LC4064ZC-5T48C	64	1.8	5	TQFP	48	32	C
	LC4064ZC-75T48C	64	1.8	7.5	TQFP	48	32	C
LC4128ZC	LC4128ZC-42M132C	128	1.8	4.2	csBGA	132	96	C
	LC4128ZC-75M132C	128	1.8	7.5	csBGA	132	96	C
	LC4128ZC-42T100C	128	1.8	4.2	TQFP	100	64	C
	LC4128ZC-75T100C	128	1.8	7.5	TQFP	100	64	C
LC4256ZC	LC4256ZC-45T176C	256	1.8	4.5	TQFP	176	128	C
	LC4256ZC-75T176C	256	1.8	7.5	TQFP	176	128	C
	LC4256ZC-45M132C	256	1.8	4.5	csBGA	132	96	C
	LC4256ZC-75M132C	256	1.8	7.5	csBGA	132	96	C
	LC4256ZC-45T100C	256	1.8	4.5	TQFP	100	64	C
	LC4256ZC-75T100C	256	1.8	7.5	TQFP	100	64	C

ispMACH 4000ZC (1.8V, Zero Power) Industrial Devices

Device	Part Number	Macrocells	Voltage	t _{PD}	Package	Pin/Ball Count	I/O	Grade
LC4032ZC	LC4032ZC-5M56I	32	1.8	5	csBGA	56	32	I
	LC4032ZC-75M56I	32	1.8	7.5	csBGA	56	32	I
	LC4032ZC-5T48I	32	1.8	5	TQFP	48	32	I
	LC4032ZC-75T48I	32	1.8	7.5	TQFP	48	32	I

ispMACH 4000C (1.8V) Commercial Devices (Cont.)

Device	Part Number	Macrocells	Voltage	t _{PD}	Package	Pin/Ball Count	I/O	Grade
LC4128C	LC4128C-27T128C	128	1.8	2.7	TQFP	128	92	C
	LC4128C-5T128C	128	1.8	5	TQFP	128	92	C
	LC4128C-75T128C	128	1.8	7.5	TQFP	128	92	C
	LC4128C-27T100C	128	1.8	2.7	TQFP	100	64	C
	LC4128C-5T100C	128	1.8	5	TQFP	100	64	C
	LC4128C-75T100C	128	1.8	7.5	TQFP	100	64	C
LC4256C	LC4256C-3FT256AC	256	1.8	3	ftBGA	256	128	C
	LC4256C-5FT256AC	256	1.8	5	ftBGA	256	128	C
	LC4256C-75FT256AC	256	1.8	7.5	ftBGA	256	128	C
	LC4256C-3FT256BC	256	1.8	3	ftBGA	256	160	C
	LC4256C-5FT256BC	256	1.8	5	ftBGA	256	160	C
	LC4256C-75FT256BC	256	1.8	7.5	ftBGA	256	160	C
	LC4256C-3F256AC ¹	256	1.8	3	fpBGA	256	128	C
	LC4256C-5F256AC ¹	256	1.8	5	fpBGA	256	128	C
	LC4256C-75F256AC ¹	256	1.8	7.5	fpBGA	256	128	C
	LC4256C-3F256BC ¹	256	1.8	3	fpBGA	256	160	C
	LC4256C-5F256BC ¹	256	1.8	5	fpBGA	256	160	C
	LC4256C-75F256BC ¹	256	1.8	7.5	fpBGA	256	160	C
	LC4256C-3T176C	256	1.8	3	TQFP	176	128	C
	LC4256C-5T176C	256	1.8	5	TQFP	176	128	C
	LC4256C-75T176C	256	1.8	7.5	TQFP	176	128	C
	LC4256C-3T100C	256	1.8	3	TQFP	100	64	C
	LC4256C-5T100C	256	1.8	5	TQFP	100	64	C
	LC4256C-75T100C	256	1.8	7.5	TQFP	100	64	C
LC4384C	LC4384C-35FT256C	384	1.8	3.5	ftBGA	256	192	C
	LC4384C-5FT256C	384	1.8	5	ftBGA	256	192	C
	LC4384C-75FT256C	384	1.8	7.5	ftBGA	256	192	C
	LC4384C-35F256C ¹	384	1.8	3.5	fpBGA	256	192	C
	LC4384C-5F256C ¹	384	1.8	5	fpBGA	256	192	C
	LC4384C-75F256C ¹	384	1.8	7.5	fpBGA	256	192	C
	LC4384C-35T176C	384	1.8	3.5	TQFP	176	128	C
	LC4384C-5T176C	384	1.8	5	TQFP	176	128	C
	LC4384C-75T176C	384	1.8	7.5	TQFP	176	128	C
LC4512C	LC4512C-35FT256C	512	1.8	3.5	ftBGA	256	208	C
	LC4512C-5FT256C	512	1.8	5	ftBGA	256	208	C
	LC4512C-75FT256C	512	1.8	7.5	ftBGA	256	208	C
	LC4512C-35F256C ¹	512	1.8	3.5	fpBGA	256	208	C
	LC4512C-5F256C ¹	512	1.8	5	fpBGA	256	208	C
	LC4512C-75F256C ¹	512	1.8	7.5	fpBGA	256	208	C
	LC4512C-35T176C	512	1.8	3.5	TQFP	176	128	C
	LC4512C-5T176C	512	1.8	5	TQFP	176	128	C
	LC4512C-75T176C	512	1.8	7.5	TQFP	176	128	C

1. Use ftBGA package. fpBGA package devices have been discontinued via PCN#14A-07.

ispMACH 4000C (1.8V) Industrial Devices

Family	Part Number	Macrocells	Voltage	t _{PD}	Package	Pin/Ball Count	I/O	Grade
LC4032C	LC4032C-5T48I	32	1.8	5	TQFP	48	32	I
	LC4032C-75T48I	32	1.8	7.5	TQFP	48	32	I
	LC4032C-10T48I	32	1.8	10	TQFP	48	32	I
	LC4032C-5T44I	32	1.8	5	TQFP	44	30	I
	LC4032C-75T44I	32	1.8	7.5	TQFP	44	30	I
	LC4032C-10T44I	32	1.8	10	TQFP	44	30	I
LC4064C	LC4064C-5T100I	64	1.8	5	TQFP	100	64	I
	LC4064C-75T100I	64	1.8	7.5	TQFP	100	64	I
	LC4064C-10T100I	64	1.8	10	TQFP	100	64	I
	LC4064C-5T48I	64	1.8	5	TQFP	48	32	I
	LC4064C-75T48I	64	1.8	7.5	TQFP	48	32	I
	LC4064C-10T48I	64	1.8	10	TQFP	48	32	I
	LC4064C-5T44I	64	1.8	5	TQFP	44	30	I
	LC4064C-75T44I	64	1.8	7.5	TQFP	44	30	I
	LC4064C-10T44I	64	1.8	10	TQFP	44	30	I
LC4128C	LC4128C-5T128I	128	1.8	5	TQFP	128	92	I
	LC4128C-75T128I	128	1.8	7.5	TQFP	128	92	I
	LC4128C-10T128I	128	1.8	10	TQFP	128	92	I
	LC4128C-5T100I	128	1.8	5	TQFP	100	64	I
	LC4128C-75T100I	128	1.8	7.5	TQFP	100	64	I
	LC4128C-10T100I	128	1.8	10	TQFP	100	64	I
LC4256C	LC4256C-5FT256AI	256	1.8	5	ftBGA	256	128	I
	LC4256C-75FT256AI	256	1.8	7.5	ftBGA	256	128	I
	LC4256C-10FT256AI	256	1.8	10	ftBGA	256	128	I
	LC4256C-5FT256BI	256	1.8	5	ftBGA	256	160	I
	LC4256C-75FT256BI	256	1.8	7.5	ftBGA	256	160	I
	LC4256C-10FT256BI	256	1.8	10	ftBGA	256	160	I
	LC4256C-5F256AI ¹	256	1.8	5	fpBGA	256	128	I
	LC4256C-75F256AI ¹	256	1.8	7.5	fpBGA	256	128	I
	LC4256C-10F256AI ¹	256	1.8	10	fpBGA	256	128	I
	LC4256C-5F256BI ¹	256	1.8	5	fpBGA	256	160	I
	LC4256C-75F256BI ¹	256	1.8	7.5	fpBGA	256	160	I
	LC4256C-10F256BI ¹	256	1.8	10	fpBGA	256	160	I
	LC4256C-5T176I	256	1.8	5	TQFP	176	128	I
	LC4256C-75T176I	256	1.8	7.5	TQFP	176	128	I
	LC4256C-10T176I	256	1.8	10	TQFP	176	128	I
	LC4256C-5T100I	256	1.8	5	TQFP	100	64	I
	LC4256C-75T100I	256	1.8	7.5	TQFP	100	64	I
	LC4256C-10T100I	256	1.8	10	TQFP	100	64	I

ispMACH 4000C (1.8V) Industrial Devices (Cont.)

Family	Part Number	Macrocells	Voltage	t _{PD}	Package	Pin/Ball Count	I/O	Grade
LC4384C	LC4384C-5FT256I	384	1.8	5	ftBGA	256	192	I
	LC4384C-75FT256I	384	1.8	7.5	ftBGA	256	192	I
	LC4384C-10FT256I	384	1.8	10	ftBGA	256	192	I
	LC4384C-5F256I ¹	384	1.8	5	fpBGA	256	192	I
	LC4384C-75F256I ¹	384	1.8	7.5	fpBGA	256	192	I
	LC4384C-10F256I ¹	384	1.8	10	fpBGA	256	192	I
	LC4384C-5T176I	384	1.8	5	TQFP	176	128	I
	LC4384C-75T176I	384	1.8	7.5	TQFP	176	128	I
	LC4384C-10T176I	384	1.8	10	TQFP	176	128	I
LC4512C	LC4512C-5FT256I	512	1.8	5	ftBGA	256	208	I
	LC4512C-75FT256I	512	1.8	7.5	ftBGA	256	208	I
	LC4512C-10FT256I	512	1.8	10	ftBGA	256	208	I
	LC4512C-5F256I ¹	512	1.8	5	fpBGA	256	208	I
	LC4512C-75F256I ¹	512	1.8	7.5	fpBGA	256	208	I
	LC4512C-10F256I ¹	512	1.8	10	fpBGA	256	208	I
	LC4512C-5T176I	512	1.8	5	TQFP	176	128	I
	LC4512C-75T176I	512	1.8	7.5	TQFP	176	128	I
	LC4512C-10T176I	512	1.8	10	TQFP	176	128	I

1. Use ftBGA package. fpBGA package devices have been discontinued via PCN#14A-07.

ispMACH 4000B (2.5V) Commercial Devices

Device	Part Number	Macrocells	Voltage	t _{PD}	Package	Pin/Ball Count	I/O	Grade
LC4032B	LC4032B-25T48C	32	2.5	2.5	TQFP	48	32	C
	LC4032B-5T48C	32	2.5	5	TQFP	48	32	C
	LC4032B-75T48C	32	2.5	7.5	TQFP	48	32	C
	LC4032B-25T44C	32	2.5	2.5	TQFP	44	30	C
	LC4032B-5T44C	32	2.5	5	TQFP	44	30	C
	LC4032B-75T44C	32	2.5	7.5	TQFP	44	30	C
LC4064B	LC4064B-25T100C	64	2.5	2.5	TQFP	100	64	C
	LC4064B-5T100C	64	2.5	5	TQFP	100	64	C
	LC4064B-75T100C	64	2.5	7.5	TQFP	100	64	C
	LC4064B-25T48C	64	2.5	2.5	TQFP	48	32	C
	LC4064B-5T48C	64	2.5	5	TQFP	48	32	C
	LC4064B-75T48C	64	2.5	7.5	TQFP	48	32	C
	LC4064B-25T44C	64	2.5	2.5	TQFP	44	30	C
	LC4064B-5T44C	64	2.5	5	TQFP	44	30	C
LC4128B	LC4128B-27T128C	128	2.5	2.7	TQFP	128	92	C
	LC4128B-5T128C	128	2.5	5	TQFP	128	92	C
	LC4128B-75T128C	128	2.5	7.5	TQFP	128	92	C
	LC4128B-27T100C	128	2.5	2.7	TQFP	100	64	C
	LC4128B-5T100C	128	2.5	5	TQFP	100	64	C
	LC4128B-75T100C	128	2.5	7.5	TQFP	100	64	C

ispMACH 4000B (2.5V) Commercial Devices (Cont.)

Device	Part Number	Macrocells	Voltage	t _{PD}	Package	Pin/Ball Count	I/O	Grade
LC4256B	LC4256B-3FT256AC	256	2.5	3	ftBGA	256	128	C
	LC4256B-5FT256AC	256	2.5	5	ftBGA	256	128	C
	LC4256B-75FT256AC	256	2.5	7.5	ftBGA	256	128	C
	LC4256B-3FT256BC	256	2.5	3	ftBGA	256	160	C
	LC4256B-5FT256BC	256	2.5	5	ftBGA	256	160	C
	LC4256B-75FT256BC	256	2.5	7.5	ftBGA	256	160	C
	LC4256B-3F256AC ¹	256	2.5	3	fpBGA	256	128	C
	LC4256B-5F256AC ¹	256	2.5	5	fpBGA	256	128	C
	LC4256B-75F256AC ¹	256	2.5	7.5	fpBGA	256	128	C
	LC4256B-3F256BC ¹	256	2.5	3	fpBGA	256	160	C
	LC4256B-5F256BC ¹	256	2.5	5	fpBGA	256	160	C
	LC4256B-75F256BC ¹	256	2.5	7.5	fpBGA	256	160	C
	LC4256B-3T176C	256	2.5	3	TQFP	176	128	C
	LC4256B-5T176C	256	2.5	5	TQFP	176	128	C
	LC4256B-75T176C	256	2.5	7.5	TQFP	176	128	C
LC4384B	LC4384B-35FT256C	384	2.5	3.5	ftBGA	256	192	C
	LC4384B-5FT256C	384	2.5	5	ftBGA	256	192	C
	LC4384B-75FT256C	384	2.5	7.5	ftBGA	256	192	C
	LC4384B-35F256C ¹	384	2.5	3.5	fpBGA	256	192	C
	LC4384B-5F256C ¹	384	2.5	5	fpBGA	256	192	C
	LC4384B-75F256C ¹	384	2.5	7.5	fpBGA	256	192	C
	LC4384B-35T176C	384	2.5	3.5	TQFP	176	128	C
	LC4384B-5T176C	384	2.5	5	TQFP	176	128	C
LC4512B	LC4512B-35FT256C	512	2.5	3.5	ftBGA	256	208	C
	LC4512B-5FT256C	512	2.5	5	ftBGA	256	208	C
	LC4512B-75FT256C	512	2.5	7.5	ftBGA	256	208	C
	LC4512B-35F256C ¹	512	2.5	3.5	fpBGA	256	208	C
	LC4512B-5F256C ¹	512	2.5	5	fpBGA	256	208	C
	LC4512B-75F256C ¹	512	2.5	7.5	fpBGA	256	208	C
	LC4512B-35T176C	512	2.5	3.5	TQFP	176	128	C
	LC4512B-5T176C	512	2.5	5	TQFP	176	128	C
	LC4512B-75T176C	512	2.5	7.5	TQFP	176	128	C

1. Use ftBGA package. fpBGA package devices have been discontinued via PCN#14A-07.

ispMACH 4000V (3.3V) Lead-Free Commercial Devices

Device	Part Number	Macrocells	Voltage	t _{PD}	Package	Pin/Ball Count	I/O	Grade
LC4032V	LC4032V-25TN48C	32	3.3	2.5	Lead-free TQFP	48	32	C
	LC4032V-5TN48C	32	3.3	5	Lead-free TQFP	48	32	C
	LC4032V-75TN48C	32	3.3	7.5	Lead-free TQFP	48	32	C
	LC4032V-25TN44C	32	3.3	2.5	Lead-free TQFP	44	30	C
	LC4032V-5TN44C	32	3.3	5	Lead-free TQFP	44	30	C
	LC4032V-75TN44C	32	3.3	7.5	Lead-free TQFP	44	30	C
LC4064V	LC4064V-25TN100C	64	3.3	2.5	Lead-free TQFP	100	64	C
	LC4064V-5TN100C	64	3.3	5	Lead-free TQFP	100	64	C
	LC4064V-75TN100C	64	3.3	7.5	Lead-free TQFP	100	64	C
	LC4064V-25TN48C	64	3.3	2.5	Lead-free TQFP	48	32	C
	LC4064V-5TN48C	64	3.3	5	Lead-free TQFP	48	32	C
	LC4064V-75TN48C	64	3.3	7.5	Lead-free TQFP	48	32	C
	LC4064V-25TN44C	64	3.3	2.5	Lead-free TQFP	44	30	C
	LC4064V-5TN44C	64	3.3	5	Lead-free TQFP	44	30	C
	LC4064V-75TN44C	64	3.3	7.5	Lead-free TQFP	44	30	C
LC4128V	LC4128V-27TN144C	128	3.3	2.7	Lead-free TQFP	144	96	C
	LC4128V-5TN144C	128	3.3	5	Lead-free TQFP	144	96	C
	LC4128V-75TN144C	128	3.3	7.5	Lead-free TQFP	144	96	C
	LC4128V-27TN128C	128	3.3	2.7	Lead-free TQFP	128	92	C
	LC4128V-5TN128C	128	3.3	5	Lead-free TQFP	128	92	C
	LC4128V-75TN128C	128	3.3	7.5	Lead-free TQFP	128	92	C
	LC4128V-27TN100C	128	3.3	2.7	Lead-free TQFP	100	64	C
	LC4128V-5TN100C	128	3.3	5	Lead-free TQFP	100	64	C
	LC4128V-75TN100C	128	3.3	7.5	Lead-free TQFP	100	64	C

ispMACH 4000V (3.3V) Lead-Free Commercial Devices (Cont.)

Device	Part Number	Macrocells	Voltage	t _{PD}	Package	Pin/Ball Count	I/O	Grade
LC4256V	LC4256V-3FTN256AC	256	3.3	3	Lead-free ftBGA	256	128	C
	LC4256V-5FTN256AC	256	3.3	5	Lead-free ftBGA	256	128	C
	LC4256V-75FTN256AC	256	3.3	7.5	Lead-free ftBGA	256	128	C
	LC4256V-3FTN256BC	256	3.3	3	Lead-free ftBGA	256	160	C
	LC4256V-5FTN256BC	256	3.3	5	Lead-free ftBGA	256	160	C
	LC4256V-75FTN256BC	256	3.3	7.5	Lead-free ftBGA	256	160	C
	LC4256V-3FN256AC ¹	256	3.3	3	Lead-free fpBGA	256	128	C
	LC4256V-5FN256AC ¹	256	3.3	5	Lead-free fpBGA	256	128	C
	LC4256V-75FN256AC ¹	256	3.3	7.5	Lead-free fpBGA	256	128	C
	LC4256V-3FN256BC ¹	256	3.3	3	Lead-free fpBGA	256	160	C
	LC4256V-5FN256BC ¹	256	3.3	5	Lead-free fpBGA	256	160	C
	LC4256V-75FN256BC ¹	256	3.3	7.5	Lead-free fpBGA	256	160	C
	LC4256V-3TN176C	256	3.3	3	Lead-free TQFP	176	128	C
	LC4256V-5TN176C	256	3.3	5	Lead-free TQFP	176	128	C
	LC4256V-75TN176C	256	3.3	7.5	Lead-free TQFP	176	128	C
	LC4256V-3TN144C	256	3.3	3	Lead-free TQFP	144	96	C
	LC4256V-5TN144C	256	3.3	5	Lead-free TQFP	144	96	C
	LC4256V-75TN144C	256	3.3	7.5	Lead-free TQFP	144	96	C
	LC4256V-3TN100C	256	3.3	3	Lead-free TQFP	100	64	C
	LC4256V-5TN100C	256	3.3	5	Lead-free TQFP	100	64	C
	LC4256V-75TN100C	256	3.3	7.5	Lead-free TQFP	100	64	C
LC4384V	LC4384V-35FTN256C	384	3.3	3.5	Lead-free ftBGA	256	192	C
	LC4384V-5FTN256C	384	3.3	5	Lead-free ftBGA	256	192	C
	LC4384V-75FTN256C	384	3.3	7.5	Lead-free ftBGA	256	192	C
	LC4384V-35FN256C ¹	384	3.3	3.5	Lead-free fpBGA	256	192	C
	LC4384V-5FN256C ¹	384	3.3	5	Lead-free fpBGA	256	192	C
	LC4384V-75FN256C ¹	384	3.3	7.5	Lead-free fpBGA	256	192	C
	LC4384V-35TN176C	384	3.3	3.5	Lead-free TQFP	176	128	C
	LC4384V-5TN176C	384	3.3	5	Lead-free TQFP	176	128	C
	LC4384V-75TN176C	384	3.3	7.5	Lead-free TQFP	176	128	C
LC4512V	LC4512V-35FTN256C	512	3.3	3.5	Lead-free ftBGA	256	208	C
	LC4512V-5FTN256C	512	3.3	5	Lead-free ftBGA	256	208	C
	LC4512V-75FTN256C	512	3.3	7.5	Lead-free ftBGA	256	208	C
	LC4512V-35FN256C ¹	512	3.3	3.5	Lead-free fpBGA	256	208	C
	LC4512V-5FN256C ¹	512	3.3	5	Lead-free fpBGA	256	208	C
	LC4512V-75FN256C ¹	512	3.3	7.5	Lead-free fpBGA	256	208	C
	LC4512V-35TN176C	512	3.3	3.5	Lead-free TQFP	176	128	C
	LC4512V-5TN176C	512	3.3	5	Lead-free TQFP	176	128	C
	LC4512V-75TN176C	512	3.3	7.5	Lead-free TQFP	176	128	C

1. Use ftBGA package. fpBGA package devices have been discontinued via PCN#14A-07.